



AP7341

300mA HIGH PSRR LOW NOISE LDO WITH ENABLE

Description

The AP7341 is a low dropout regulator with high output voltage accuracy, low R_{DSON} , high PSRR, low output noise and low quiescent current. This regulator is based on a CMOS process.

The AP7341 consists of a voltage reference, error amplifier, current limit circuit and an enable input to turn it on and off. With the integrated resistor network fixed output voltage versions can be delivered.

With its low power consumption and line and load transient response, the AP7341 is well suited for low power handheld communication equipment. The AP7341 is packaged in an X2-DFN1010-4 package and allows for smallest footprint and dense PCB layout.

Features

- Low V_{IN} and Wide V_{IN} Range: 1.7V to 5.25V
- Guarantee Output Current: 300mA
- V_{OUT} Accuracy ±1%
- Ripple Rejection 75dB at 1kHz
- Low Output Noise, 60µVrms from 10Hz to 100kHz
- Quiescent Current as Low as 35µA
- V_{OUT} Fixed 1.1V to 3.3V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



 $\mathsf{PIN1}-\mathsf{V}_{\mathsf{OUT}},\,\mathsf{PIN2}-\mathsf{GND},\,\mathsf{PIN3}-\mathsf{EN},\,\mathsf{PIN4}-\mathsf{V}_{\mathsf{IN}}$

Applications

- Smart Phone/Pad
- RF Supply
- Cameras
- Portable Video
- Portable Media Player
- Wireless Adapter
- Wireless Communication

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit



Figure 1 Typical Application Circuit



Functional Block Diagram



Pin Descriptions

 /		
Pin Number	Pin Name	Function
1	V _{OUT}	Power Output Pin
2	GND	Ground
3	EN	Enable Pin This pin should be driven either high or low and must not be floating. Driving this pin high enables the regulator, while pulling it low puts the regulator into shutdown mode
4	V _{IN}	Power Input Pin
_	Thermal Pad	In PCB layout, prefer to use large copper area to cover this pad for better thermal dissipation, then connect this area to GND or leave it open. However, do not use it as GND electrode function alone

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Ratings	Unit
VIN	Input Voltage	6.0	V
V _{CE}	Input Voltage EN	6.0	V
V _{OUT}	Output Voltage	-0.3 to V _{IN} +0.3	V
lout	Output Current	400	mA
PD	Power Dissipation	400	mW
T _A	Operating Ambient Temperature	-40 to +85	°C
T _{STG}	Storage Temperature	-55 to +125	°C

Note: 4. a). Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

b). Ratings apply to ambient temperature at +25°C. The JEDEC High-K board design used to derive this data was a 2in. x 2in. multilayer board with 1oz internal power and ground planes and 2oz copper traces on the top and bottom of the board.



Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	1.7	5.25	V
lout	Output Current	0	300	mA
T _A	Operating Ambient Temperature	-40	+85	°C

Electrical Characteristics (@T_A = +25°C, $V_{IN} = V_{EN} = V_{OUT} + 1.0V$, $C_{IN} = C_{OUT} = 1.0\mu$ F, $I_{OUT} = 1.0m$ A, unless otherwise specified.)

Parameter	Conditions		Min	Тур	Max	Unit
Input Voltage	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		1.7	_	5.25	V
	$V_{IN} = V_{OUT-Nom}$ +1.0V to 5.25V, IOUT= 1mA to 300mA	T _A = +25°C	-1	—	1	%
Output Voltage Accuracy (Note 11)		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	-1.5	_	+1.5	
Line Regulation (dV _{OUT} /dV _{IN} /V _{OUT})	$V_{IN} = (V_{OUT-Nom}+1.0V)$ to 5.25V, I _C	ut = 1.0mA	—	0.02	0.1	%/V
Load Regulation (dV _{OUT} /V _{OUT})	V _{IN} = V _{OUT-Nom} +1.0V, I _{OUT} = 1mA	to 300mA	_	15	30	mV
Quiescent Current (Note 6)	I _{OUT} = 0mA		—	35	50	μA
Istandby	V _{EN} = 0V (Disabled)		_	0.01	1.0	μA
Output Current	—		300	—	—	mA
Fold-back Short Current (Note 7)	VOUT Short to Ground		—	55	—	mA
PSRR (Note 8)	$V_{IN} = [V_{OUT} + 1V] VDC + 0.2Vp-pAC V_{OUT} \ge 1.8V,$ $I_{OUT} = 30mA$	f = 1kHz	_	75	_	dB
Output Noise Voltage (Notes 8 & 9)	BW = 10Hz to 100kHz, I _{OUT} = 30mA		—	60	—	μVrms
	I _{OUT} = 150mA	1.1V ≤ V _{OUT} < 1.5V	—	0.50	0.62	V
		1.5V ≤ V _{OUT} < 1.7V	—	0.38	0.47	
		1.7V ≤ V _{OUT} < 2.0V	_	0.34	0.42	
		$2.0V \le V_{OUT} < 2.5V$	_	0.28	0.36	
Dropout Voltage (Note 5)		2.5V ≤ V _{OUT} < 2.8V	_	0.22	0.30	
		$2.8V \le V_{OUT} \le 3.3V$	_	0.21	0.27	
	I _{OUT} = 300mA	V _{OUT} = 1.8V	_	0.50	0.65	
		V _{OUT} = 2.5V	_	0.37	0.48	
		V _{OUT} = 3.3V	_	0.30	0.40	
Output Voltage Temperature Coefficient	$I_{OUT} = 30$ mA, $T_A = -40$ °C to +85°C		_	±30	_	ppm/°C
EN Input Low Voltage			0	_	0.5	V
EN Input High Voltage			1.3	—	5.25	V
EN Input Leakage	$V_{EN} = 0$, $V_{IN} = 5.0V$ or $V_{EN} = 5.0V$, $V_{IN} = 0V$		-1.0	—	+1.0	μA
On Resistance of N-Channel for Auto-Discharge (Note 10)	$V_{IN} = 4.0V V_{EN} = 0V$ (Disabled)		_	30	_	Ω

5. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
6. Quiescent current is defined here is the difference in current between the input and the output.
7. Short circuit current is measured with VOUT pulled to GND.
9. This provide the imput and the output. Notes:

8. This specification is guaranteed by design.

9. To make sure lowest environment noise minimizes the influence on noise measurement.

10. AP7341 has 2 options for output, built-in discharge and non-discharge.

11. Potential multiple grades based on following output voltage accuracy.



Typical Characteristics



































1000

10000

Frequency f (Hz)

100000

1000000

0

100











Application Information

Output Capacitor

An output capacitor (C_{OUT}) is needed to improve transient response and maintain stability. The AP7341 is stable with very small ceramic output capacitors. The ESR (equivalent series resistance) and capacitance drives the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the ground pin and care should be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps it is recommended to utilize an input capacitor (C_{IN}). A minimum 0.47 μ F ceramic capacitor is recommended between V_{IN} and GND pins to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pins.

Enable Control

The AP7341 is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to V_{IN} pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section.

Short Circuit Protection

When V_{OUT} pin is short-circuit to GND, short circuit protection will be triggered and clamp the output current to approximately 60mA. This feature protects the regulator from overcurrent and damage due to overheating.

Layout Considerations

For good ground loop and stability, the input and output capacitors should be located close to the input, output, and ground pins of the device. The regulator ground pin should be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace should be used for large current paths from V_{IN} to V_{OUT}, and load circuit.

ESR vs. Output Current

Ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph. Measurement conditions: Frequency Band: 10Hz to 2MHz, Temperature: -40° C to $+85^{\circ}$ C



AP7341



-7/7R

Ordering Information (Note 12)



Note: 12. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

FS4

X2-DFN1010-4

Marking Information

AP7341D-XXFS4-7/7R

(1) X2-DFN1010-4



XX : Identification Code

5,000/Tape & Reel

- X : A~Z : Internal code



Marking Information (Cont.)

Part Number	Package	Identification Code
AP7341-11FS4-7	X2-DFN1010-4	TF
AP7341-12FS4-7	X2-DFN1010-4	T2
AP7341-135FS4-7	X2-DFN1010-4	XF
AP7341-15FS4-7	X2-DFN1010-4	T3
AP7341-18FS4-7	X2-DFN1010-4	T4
AP7341-185FS4-7	X2-DFN1010-4	T5
AP7341-1051 54-7 AP7341-22FS4-7	X2-DFN1010-4	TH
AP7341-22FS4-7	X2-DFN1010-4	T6
AP7341-23F34-7 AP7341-28FS4-7	X2-DFN1010-4	T7
AP7341-285FS4-7 AP7341-285FS4-7	X2-DFN1010-4	
		T8
AP7341-295FS4-7 AP7341-30FS4-7	X2-DFN1010-4 X2-DFN1010-4	8A T9
AP7341-30F34-7 AP7341-31FS4-7	X2-DFN1010-4	TC
		-
AP7341-32FS4-7	X2-DFN1010-4	TD
AP7341-33FS4-7	X2-DFN1010-4	TE
AP7341D-11FS4-7	X2-DFN1010-4	UF
AP7341D-12FS4-7	X2-DFN1010-4	U2
AP7341D-135FS4-7	X2-DFN1010-4	XG
AP7341D-15FS4-7	X2-DFN1010-4	U3
AP7341D-18FS4-7	X2-DFN1010-4	U4
AP7341D-185FS4-7	X2-DFN1010-4	U5
AP7341D-22FS4-7	X2-DFN1010-4	UH
AP7341D-25FS4-7	X2-DFN1010-4	U6
AP7341D-28FS4-7	X2-DFN1010-4	U7
AP7341D-285FS4-7	X2-DFN1010-4	U8
AP7341D-295FS4-7	X2-DFN1010-4	9A
AP7341D-30FS4-7	X2-DFN1010-4	U9
AP7341D-31FS4-7	X2-DFN1010-4	UC
AP7341D-32FS4-7	X2-DFN1010-4	UD
AP7341D-33FS4-7	X2-DFN1010-4	UE
AP7341-11FS4-7R	X2-DFN1010-4	4A
AP7341-12FS4-7R	X2-DFN1010-4	4B
AP7341-135FS4-7R	X2-DFN1010-4	4R
AP7341-15FS4-7R	X2-DFN1010-4	4C
AP7341-18FS4-7R	X2-DFN1010-4	4D
AP7341-185FS4-7R	X2-DFN1010-4	4E
AP7341-22FS4-7R	X2-DFN1010-4	4F
AP7341-25FS4-7R	X2-DFN1010-4	4G
AP7341-28FS4-7R	X2-DFN1010-4	4H
AP7341-285FS4-7R	X2-DFN1010-4	4J
AP7341-295FS4-7R	X2-DFN1010-4	4S
AP7341-30FS4-7R	X2-DFN1010-4	4K
AP7341-31FS4-7R	X2-DFN1010-4	4M
AP7341-32FS4-7R	X2-DFN1010-4	4N
AP7341-33FS4-7R	X2-DFN1010-4	4P
AP7341D-11FS4-7R	X2-DFN1010-4	5A
AP7341D-12FS4-7R	X2-DFN1010-4	5B
AP7341D-135FS4-7R	X2-DFN1010-4	5R
AP7341D-15FS4-7R	X2-DFN1010-4	5C
AP7341D-18FS4-7R	X2-DFN1010-4	5E
AP7341D-185FS4-7R	X2-DFN1010-4	5D
AP7341D-22FS4-7R	X2-DFN1010-4	5F
AP7341D-25FS4-7R	X2-DFN1010-4	5G
AP7341D-28FS4-7R	X2-DFN1010-4	5J
AP7341D-285FS4-7R	X2-DFN1010-4	5H
AP7341D-295FS4-7R	X2-DFN1010-4	55
AP7341D-2951-34-7R AP7341D-30FS4-7R	X2-DFN1010-4	53 5K
AP7341D-31FS4-7R	X2-DFN1010-4	5M
AP7341D-31F34-7R AP7341D-32FS4-7R	X2-DFN1010-4	5M
	X2-DFN1010-4	5P
AP7341D-33FS4-7R	72-DEN1010-4	54



Package Outline Dimensions (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1010-4				
Dim	Min	Max	Тур	
Α	-	0.40	0.39	
A1	0.00	0.05	0.02	
A3	-	-	0.13	
b	0.20	0.30	0.25	
D	0.95	1.05	1.00	
D2	0.38	0.58	0.48	
E	0.95	1.05	1.00	
E2	0.38	0.58	0.48	
е	-	-	0.65	
L	0.20	0.30	0.25	
L1	0.27	0.37	0.32	
L2	0.02	0.12	0.07	
Z	-	-	0.050	
All Dimensions in mm				

X2-DFN1010-4

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value
	(in mm)
С	0.650
Х	0.250
X1	0.480
X2	0.900
X3	0.070
Y	0.400
Y1	0.470
Y2	0.220
Y3	0.480
Y4	1.300
Y5	0.180



Tape Orientation

For AP7341-XXFS4-7 & AP7341D-XXFS4-7



For AP7341-XXFS4-7R & AP7341D-XXFS4-7R





Note: 13. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.



AP7341

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